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Atty. Docket No.: 10729-P67464USO o

CUSTOMER NUMBER: 00136

Honorable Commissioner for Patents Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application in the name of:

Jae Soon KWON of Chungcheongbuk-do, Republic of Korea,

for **METHOD OF SEMICONDUCTOR DEVICE ISOLATION**. The application comprises a $\underline{15}$ -page specification including $\underline{7}$ claims (2 independents) and Abstract, $\underline{8}$ sheets of drawings (Figs. 1A-5G), and a Declaration and Power of Attorney.

Also accompanying this application for filing are:

- (1) Assignment document, cover sheet and \$40.00 fee for recordation of Assignment;
- (2) Information Disclosure Statement; PTO-1449 form and copies of references; and
- (3) A certified copy of Korean Application No. 2001-60631, filed September 28, 2001, the priority of which is claimed under 35 U.S.C. §119.

The filing fee has been calculated as shown:

Large Entity \$740.00Total Claims=07; in excess of 20 = 0 x (\$18.00) = 0.00 Total Ind. Claims=02; in excess of 03 = 0 x (\$84.00) = + 0.00 TOTAL FILING FEE: \$740.00

A check in the amount of \$780.00, is enclosed to cover the Filing Fee and an Assignment Recordation Fee. The Commissioner is hereby authorized to charge payment of any fees set forth in Sections 1.16 or 1.17 during the pendency of this application, or credit any overpayment, to deposit Account No. 06-1358. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

By: Yoon S. Ham

Reg. No. 45,307

Enclosures YSH:ecl